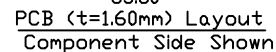
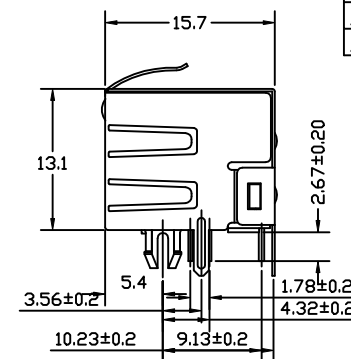


REVISION RECORD				
REV	ECD	DESCRIPTION	DRFT	CHKD
1		Modify Drawing	yanglin 08/24/05	
2		Modify Drawing	yanglin 08/26/05	
3		ADD P/N	yanglin 09/27/05	



ELECTRICAL:

- PART NUMBER: E 5J 8 8 - X X X J X X-L

—PLATING:1-3u" 2-6u"
3-15u" 4-30u" 5-50u"

"LED TYPE" TIN LEAD SHIELD STAMPED PIN.
"LED TYPE" NI LEAD SHIELD STAMPED PIN.
"LED TYPE" NI LEAD SHIELD ROUND PIN.
"LED TYPE" TIN LEAD SHIELD ROUND PIN.

J-W/O FRE LOGO FR52

—C-4 PORTS
H-4 PORTS,CUT BEHIND SHIDLE FEET.

- 1-NO TAB
- 2-TOP TABS.
- 3-SIDE TABS.
- 4-TOP TABS & SIDE TABS.

MECHANICAL:

1. HOUSING MATERIAL : FR52 UL94V-0.
2. INSERT MATERIAL : FR52 UL94V-0.
3. BACK PLATE MATERIAL : FR52 UL94V-0
4. LED SIZE : 3.2*2.0*4.0*P=2.54mm. Δ
5. SHIELD MATERIAL : COPPER ALLOY 0.25mm THICKNESS PLATING NI.
6. CONTACT MATERIAL : PHOSPHOR BRONZE 0.35mm THICKNESS OR ϕ 0.46mm.
7. PLATING : GOLD PLATING OVER NICKEL.
8. PCB RETENTION PRE-SOLDER : 1 LB MIN.
9. PCB RETENTION POST-SOLDER: 10 LBS MIN.

1. STORAGE : -40°C TO +85°C.
2. OPERATION : -40°C TO +85°C.
3. WAVE SOLDERING TEMPERATURE: 255~265°C (5~10 SECONDS)
MATES WITH MODULAR PLUG CONFORMING TO
FCC PART 68, SUBPART F.
CUL FILE NO. E163191

DETACHED LISTS	MM (INCH)		DFTD PETERS		DATE 03/22/05		FULL RISE ELECTRONIC CO., LTD					
	TOLERANCES EXCEPT AS NOTED		CHKD JAKE		DATE 2005/09/29							
			MM		MFD		DATE					
	.0 ± 0.20		APPVL LUSHENG		DATE 2005/08/29		TITLE					
	.00 ± 0.15		MATERIAL :		RJ45SIDE ENTRY LED GANGJACK 4 PORTS							
	.000 ± 0.075											
	ANGLES ±		QT'Y :		DRAWING NO. G5J3A05-LA				SIZE		REV	
			FINISH:		/PART NO. SEE NOTE				A3		3	
			SCALE :									
	THIRD ANGLE PROJECTION		DO NOT SCALE DRAWING				SHEET 1		OF 1			